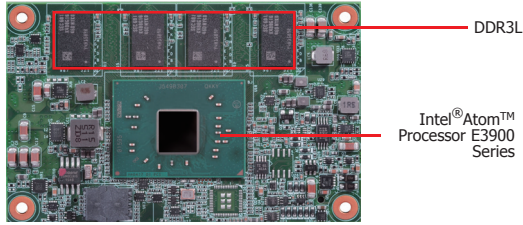
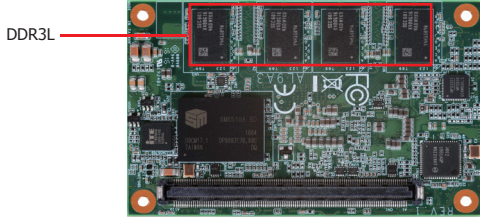


AL9A3

Atom



TOP



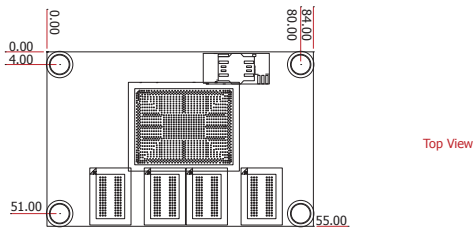
BOTTOM

Features

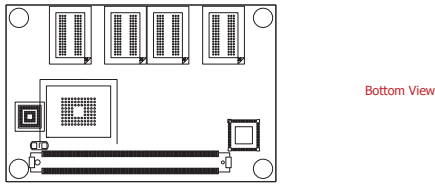
- Dual Channel DDR3L 1600MHz Memory Down up to 8GB
- 1 LVDS/eDP, 1 DDI (HDMI/DVI/DP)
Supports dual displays: DDI + LVDS/eDP
- DP++ resolution supports up to 4096x2160 @ 60Hz
- Multiple expansions: 4 PCIe x1
- Rich I/O: 1 Intel GbE, 2 USB 3.0, 8 USB 2.0



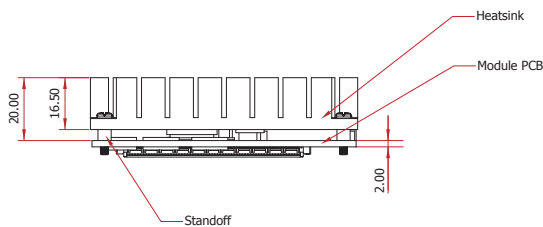
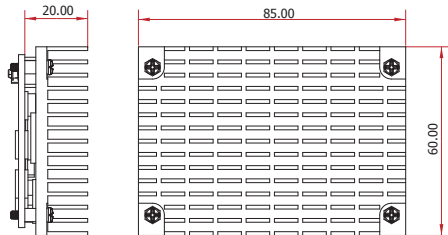
Mechanical Drawing



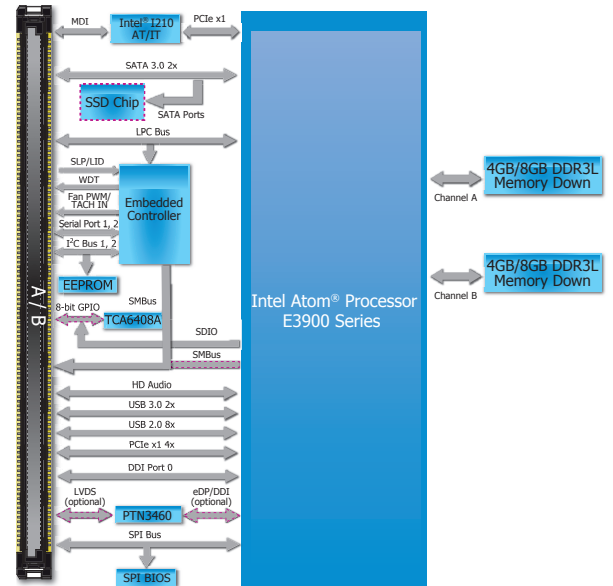
Top View



Bottom View



Block Diagram



Specifications

SYSTEM	Processor	Intel® Atom™ Processor E3900 Series, BGA 1296 Intel® Atom™ x7-E3950 Processor, Quad Core, 2M Cache, 1.6GHz (2.0GHz), 12W Intel® Atom™ x5-E3940 Processor, Quad Core, 2M Cache, 1.6GHz (1.8GHz), 9.5W Intel® Atom™ x5-E3930 Processor, Dual Core, 2M Cache, 1.3GHz (1.8GHz), 6.5W Intel® Pentium® Processor N4200, Quad Core, 2M Cache, 1.1GHz (2.5GHz), 6W Intel® Celeron® Processor N3350, Dual Core, 2M Cache, 1.1GHz (2.4GHz), 6W	
	Memory	4GB/8GB Memory Down	Dual Channel DDR3L 1600MHz
	BIOS	AMI SPI 128Mbit (supports UEFI boot only)	
GRAPHICS	Controller	Intel® HD Graphics	
	Feature	OpenGL 5.0, DirectX 12, OpenCL 2.1 HW Decode: AVC/H.264, MPEG2, VC1, WMV9, JPEG/MJPEG, HEVC/H.265, VP8, VP9, MVC HW Encode: AVC/H.264, JPEG/MJPEG, HEVC/H.265, VP8, VP9, MVC	
	Display	1 x DDI (HDMI/DVI/DP++) 1 x LVDS/eDP	LVDS: single channel 24-bit, resolution up to 1366x768 @ 60Hz HDMI: resolution up to 3840x2160 @ 30 Hz DP++: resolution up to 4096x2160 @ 60Hz eDP: resolution up to 3840x2160 @ 60Hz
	Dual Display	DDI + LVDS	DDI + eDP
EXPANSION	Interface	4 x PCIe x1 (Gen 2) 1 x SDIO (available upon request) 1 x LPC 1 x I ² C 1 x SMBus 1 x SPI 2 x UART (TX/RX)	
AUDIO	Interface	HD Audio	
ETHERNET	Controller	1 x Intel® I210AT (10/100/1000Mbps) (0°C to 60°C) 1 x Intel® I210IT (10/100/1000Mbps) (-40°C to 85°C)	
I/O	USB	2 x USB 3.0 8 x USB 2.0	
	SATA	2 x SATA 3.0 (up to 6Gb/s)	
	SSD	1 x 4GB/8GB/16GB/32GB/64GB SSD (available upon request)	
	GPIO	1 x 8-bit GPIO	
WATCHDOG TIMER	Output & Interval	System Reset, Programmable via Software from 1 to 255 Seconds	
POWER	Type	4.75V~20V, 5VSB, VCC_RTC (ATX mode)	4.75V~20V, VCC_RTC (AT mode)
	Consumption	Typical: E3940: 12V @ 0.34A (4.08W) Max.: E3940: 12V @ 1.62A (19.44W)	
OS SUPPORT (UEFI ONLY)		Windows 10 IoT Enterprise 64-bit	Linux
ENVIRONMENT	Temperature	Operating: 0 to 60°C -40 to 85°C	Storage: -40 to 85°C
	Humidity	Operating: 5 to 90% RH	Storage: 5 to 90% RH
	MTBF	1,090,551 hrs @ 25°C; 509,776 hrs @ 45°C; 283,622 hrs @ 60°C Calculation model: Telcordia Issue 2 Environment: GB, GC – Ground Benign, Controlled	
MECHANICAL	Dimensions	COM Express® Mini	84mm (3.30") x 55mm (2.16")
	Compliance	PICMG COM Express® R2.1, Type 10	

Ordering Information

Model Name	P/N	Processor	Memory	DIO/SDIO	LVDS/eDP	GbE	USB 3.0	USB 2.0	Power	Thermal	Temp.
AL9A3-B80-N4200	770-AL9A31-200G	N4200	8 GB	DIO	LVDS	1	2	8	ATX/AT	Fanless	0 to 60°C
AL9A3-B40-N3350	770-AL9A31-600G	N3350	4 GB	DIO	LVDS	1	2	8	ATX/AT	Fanless	0 to 60°C
AL9A3-B40-E3950	770-AL9A31-700G	E3950	4 GB	DIO	LVDS	1	2	8	ATX/AT	Fanless	0 to 60°C
AL9A3-T40-E3940	770-AL9A31-800G	E3940	4 GB	DIO	LVDS	1	2	8	ATX/AT	Fanless	-40 to 85°C
AL9A3-T40-E3930	770-AL9A31-900G	E3930	4 GB	DIO	LVDS	1	2	8	ATX/AT	Fanless	-40 to 85°C

Note: N4200 and N3350 are supported upon request with MOQ requirement.

Packing List

• 1 AL9A3 board	
• 1 Heat sink	A71-008114-000G (E Series) A71-008114-010G (N Series)

Optional Items

• COM100-B carrier board kit: 770-COM104-000G
• Heat spreader: A71-808304-000G (E Series) A71-808305-000G (N Series)